

# Devcon Floor Patch™ Resurfacer

Epoxy; Epoxide

Devcon

Message:

Self leveling, filled epoxy system for repairing heavily spalled concrete floors.

Intended Use:

For repairing heavily spalled, fragmented concrete floors.

A minimum thickness of 0.25" is recommended.

Product Features:

Self-leveling

Bonds to metal and concrete

Low shrinkage

Resists industrial chemicals

Mixes easily

General Information			
Filler / Reinforcement	Filler		
Features	Adhesiveness		
	Good chemical resistance		
	Low shrinkage		
Uses	Floor maintenance/repair		
	Repair Materials		
Appearance	Grey		
Physical	Nominal Value	Unit	Test Method
Density <sup>1</sup>	2.00	g/cm <sup>3</sup>	
Solid content-by Volume	100	%	
Temperature Resistance	82	°C	
Hardness	Nominal Value	Unit	Test Method
Durometer Hardness (Shore D)	85		ASTM D2240
Mechanical	Nominal Value	Unit	Test Method
Compressive Strength	134	MPa	ASTM D695
Thermoset	Nominal Value	Unit	
Thermoset Components			
	Mixing ratio by weight: 4.5		
Resin	Mixing ratio by capacity: 4.2		

Mixing ratio by weight: 1.0

Hardening method	Mixing ratio by capacity: 1.0	
Pot Life (24°C)	40	min
Thermoset Mix Viscosity	5000	cP
Additional Information	Nominal Value	Unit
Cured 7 days @ 75°F		
Uncured Properties	Nominal Value	Unit
Curing Time	24	hr
NOTE		
1.	Mixed	

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#### Recommended distributors for this material

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